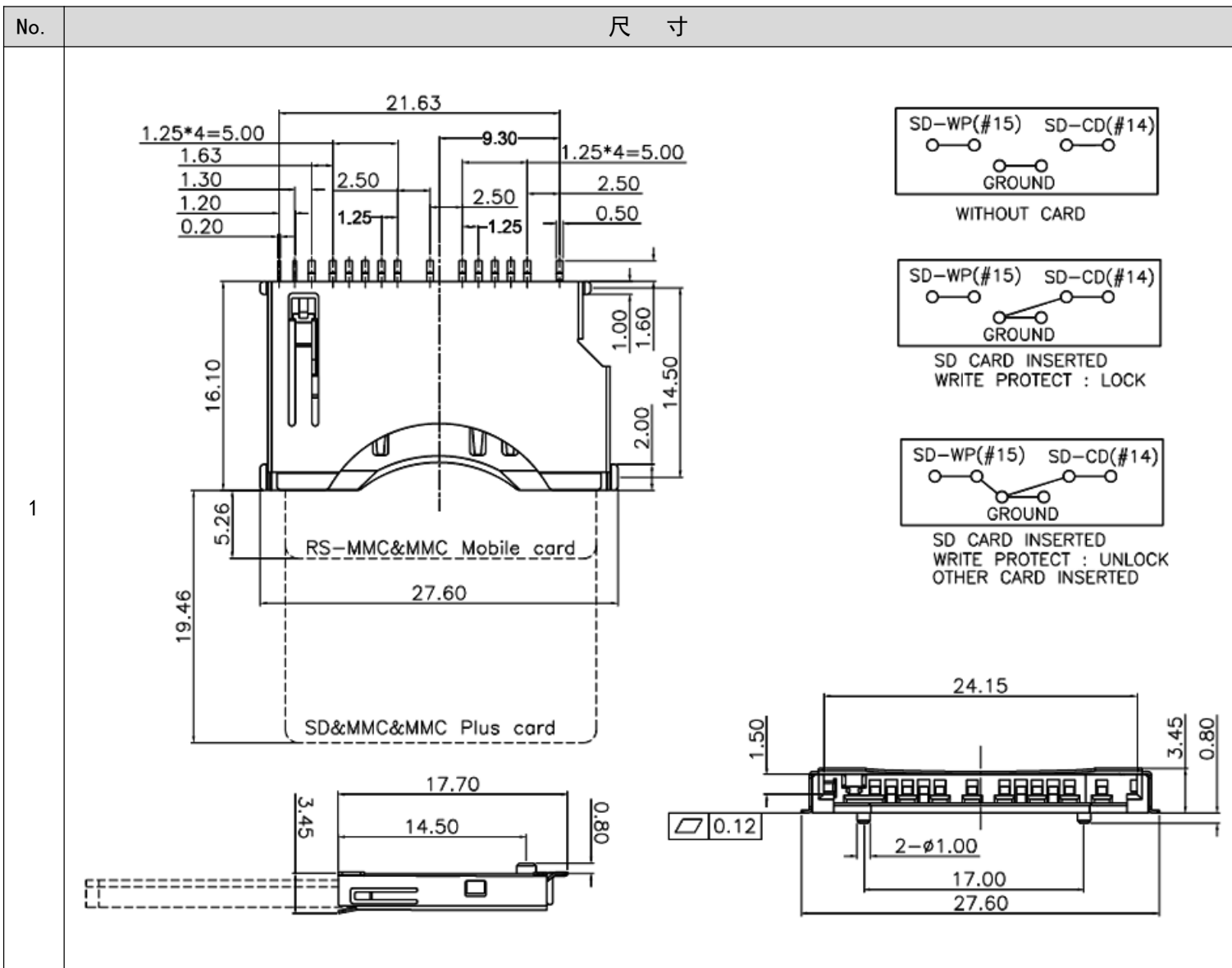
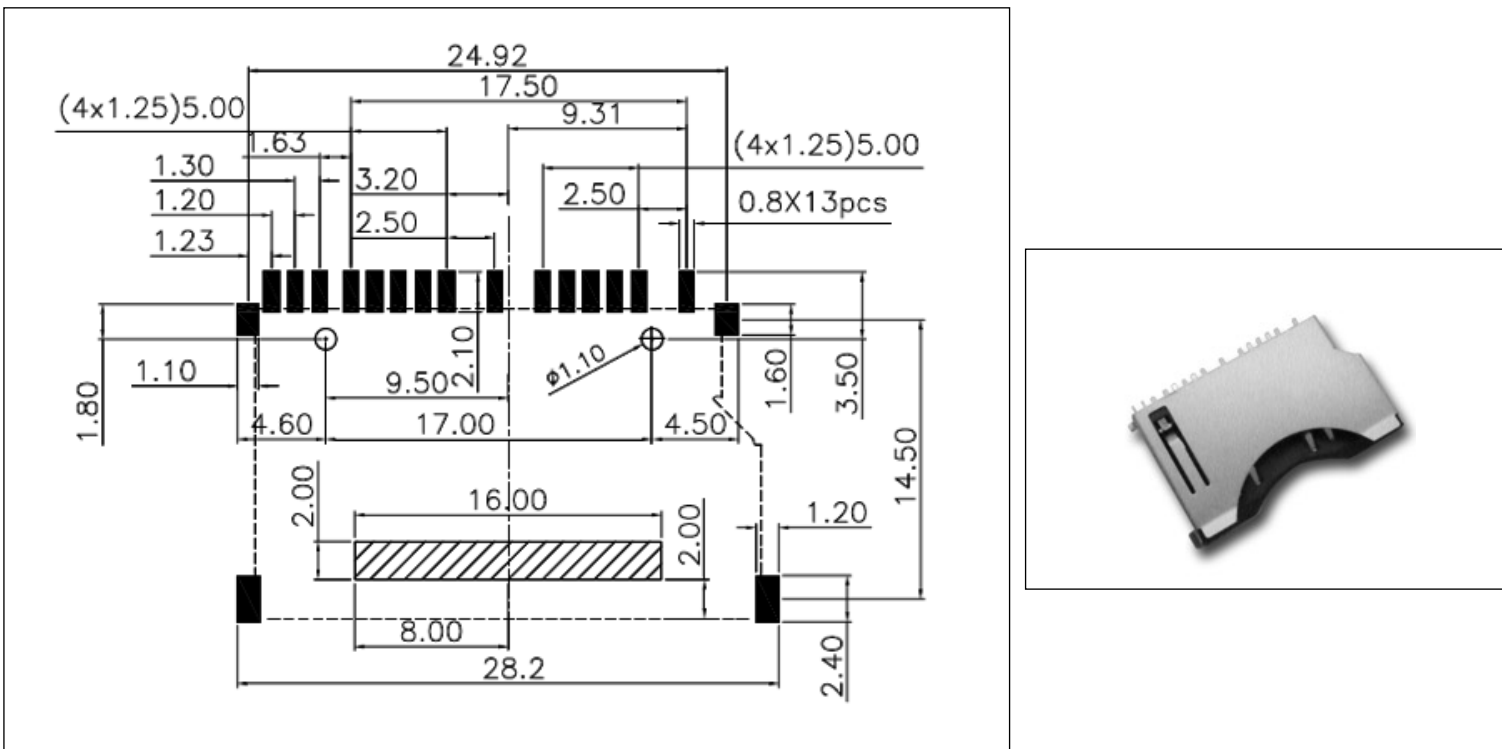


■ 外形图



■ P.C.B 尺寸



SPECIFICATION

1.MATERIAL

Insulator: High Temperature Thermoplastic,
UL94V-0

Contact: Copper Alloy

Shell: Copper Alloy

2.PLATING

Contact Area: Gold PLATED Over Ni.

Solder Tail: Sn PLATED Over Ni.

Shell Solder Area: Gold PLATED Over Ni.

3.ELECTRICAL

Operating Temperature: -25°C TO +90°C

Current Rating :0.5mA max.

Contact Resistance:100m Ω max.

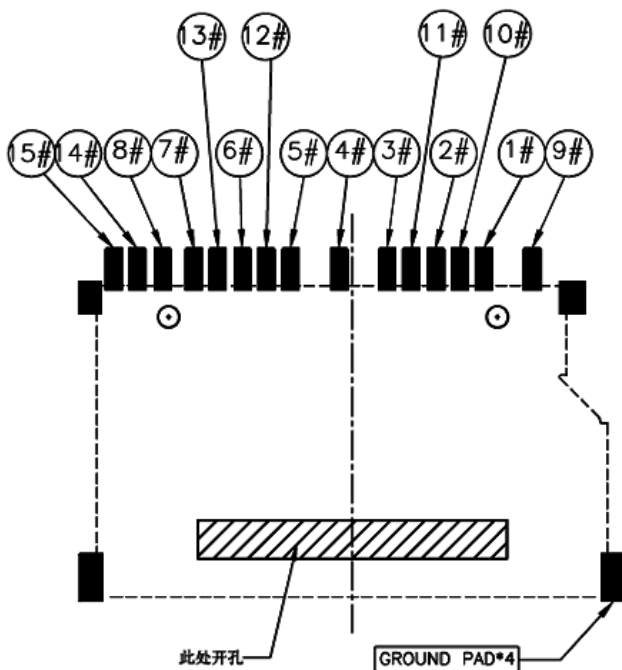
Insulation Resistance:1000M Ω min./500VDC

4.MECHANICAL

Mating Cycles:10,000 Insertions

INSERTION FORCE: 40N MAX.

SEPARATION FORCE: 2N MIN.



PIN DESIGN:

PIN NO	PIN DEFINITION	MEMORY CARD PIN NO.
1#	RSV/DAT3	MMC4.0&RS-MMC4.0&MMC&RS-MMC&SD
2#	CMD	MMC4.0&RS-MMC4.0&MMC&RS-MMC&SD
3#	VSS1	MMC4.0&RS-MMC4.0&MMC&RS-MMC&SD
4#	VDD	MMC4.0&RS-MMC4.0&MMC&RS-MMC&SD
5#	CLK	MMC4.0&RS-MMC4.0&MMC&RS-MMC&SD
6#	VSS2	MMC4.0&RS-MMC4.0&MMC&RS-MMC&SD
7#	DAT 0	MMC4.0&RS-MMC4.0&MMC&RS-MMC&SD
8#	DAT 1	MMC4.0&RS-MMC4.0&SD
9#	DAT 2	MMC4.0&RS-MMC4.0&SD
10#	DAT 4	MMC4.0&RS-MMC4.0
11#	DAT 5	MMC4.0&RS-MMC4.0
12#	DAT 6	MMC4.0&RS-MMC4.0
13#	DAT 7	MMC4.0&RS-MMC4.0
14#	CD	SD
15#	WP	SD

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